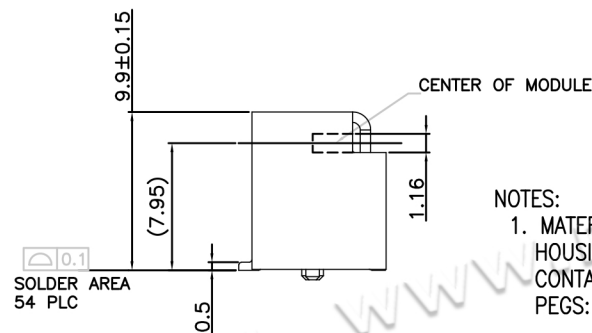
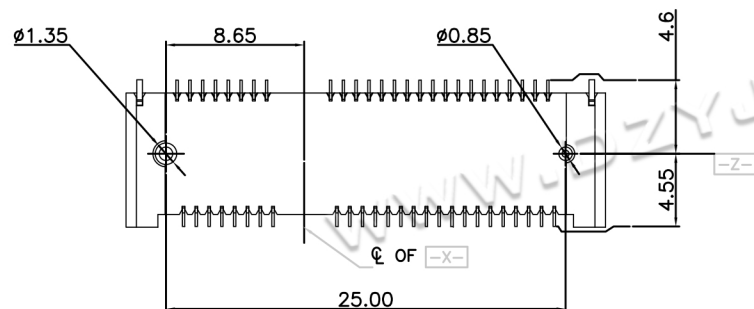
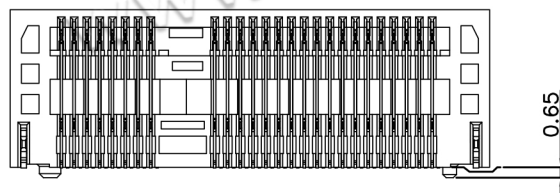
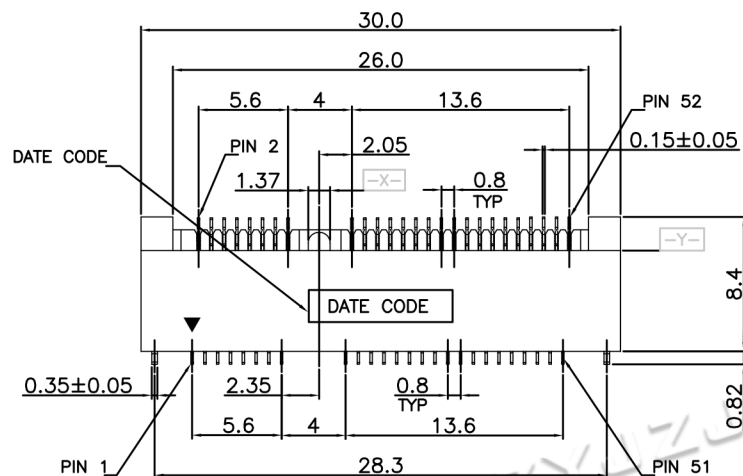




## NOTES:

1. MATERIAL:  
HOUSING: THERMOPLASTIC, HIGH TEMP, UL94V-0, BLACK COLOR,  
CONTACTS: COPPER ALLOY.  
PEGS: COPPER ALLOY.

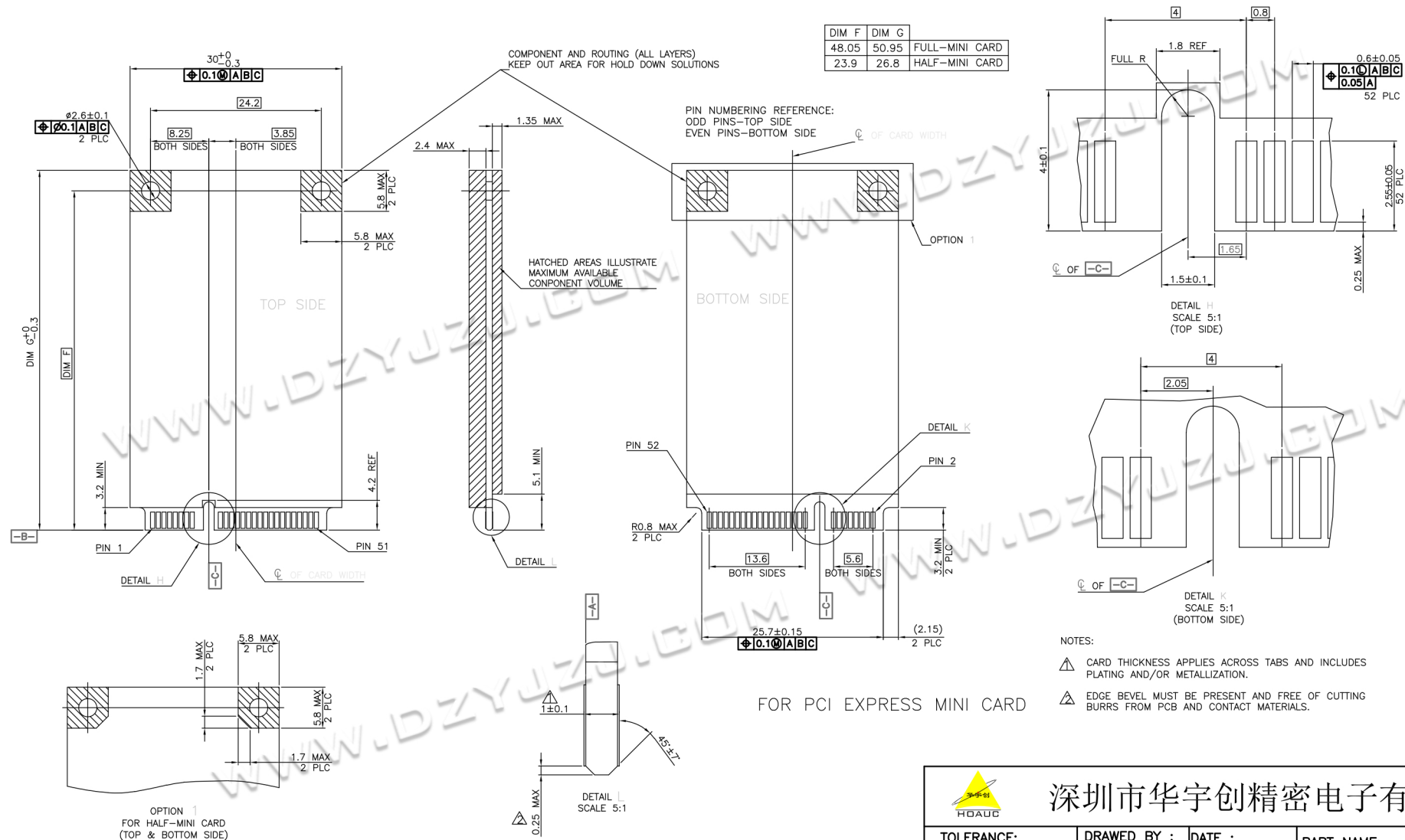
## 2. FINISH:

CONTACTS: GOLD FLASH PLATING ON THE CONTACT AREA,  
1u" MIN. GOLD PLATING ON THE SOLDER TAILS,  
50 u" MIN. NICKEL UNDERPLATING OVER ALL.  
PEGS: 120u" MIN. MATTE-TIN OVER 50u" MIN. NICKEL.

## 3. PACKAGING : TAPE &amp; REEL

|                                                                                                                                                                                                                  |                    |                      |                               |                 |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------|----------------------|-------------------------------|-----------------|
| <div></div> <div>深圳市华宇创精密电子有限公司</div>                                                                                       |                    |                      |                               |                 |
| TOLERANCE:<br>X.X ±0.30<br>X.XX ±0.25<br>X.XXX ±0.15<br><br>X.* ±2°    X.X* ±0.5°                                                                                                                                | DRAWN BY :<br>陈一鸣  | DATE :<br>2014-02-23 | PART NAME:<br>MINI PCI-E 9.9H |                 |
|                                                                                                                                                                                                                  | CHECKED BY:<br>马跃  | DATE :<br>2014-02-23 | PART NO.                      | HYC43-PCI52-990 |
| <div></div> <div>UNIT: mm [inch]</div> | APPROVED BY:<br>邱敏 | DATE :<br>2014-02-23 | MOLD NO.                      |                 |
|                                                                                                                                                                                                                  |                    |                      | DRAW NO:                      | HYC-2411291042  |
| SCALE:1:1                                                                                                                                                                                                        | SIZE: A4           |                      | SHEET NO.                     | 1 OF 1          |

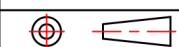




深圳市华宇创精密电子有限公司

TOLERANCE:

X.X ±0.30  
X.XX ±0.25  
X.XXX ±0.15  
X.X' ±2" X.X' ±0.5"



UNIT: mm [inch]  
SCALE: 1:1 SIZE: A4

DRAWN BY :

陈一鸣

DATE :

2014-02-23

CHECKED BY :

马跃

DATE :

2014-02-23

APPROVED BY :

邱敏

DATE :

2014-02-23

PART NAME:

MINI PCI-E 9.9H

PART NO.

HYC43-PCI52-990

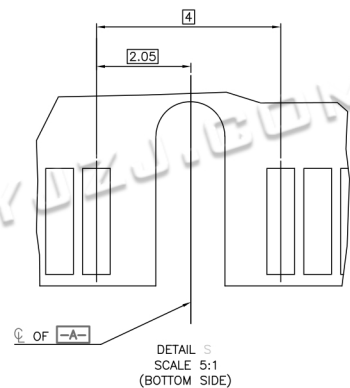
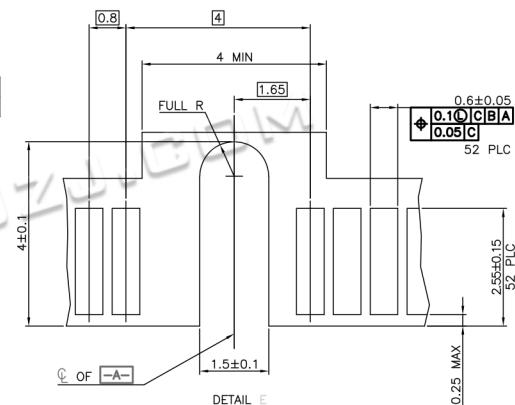
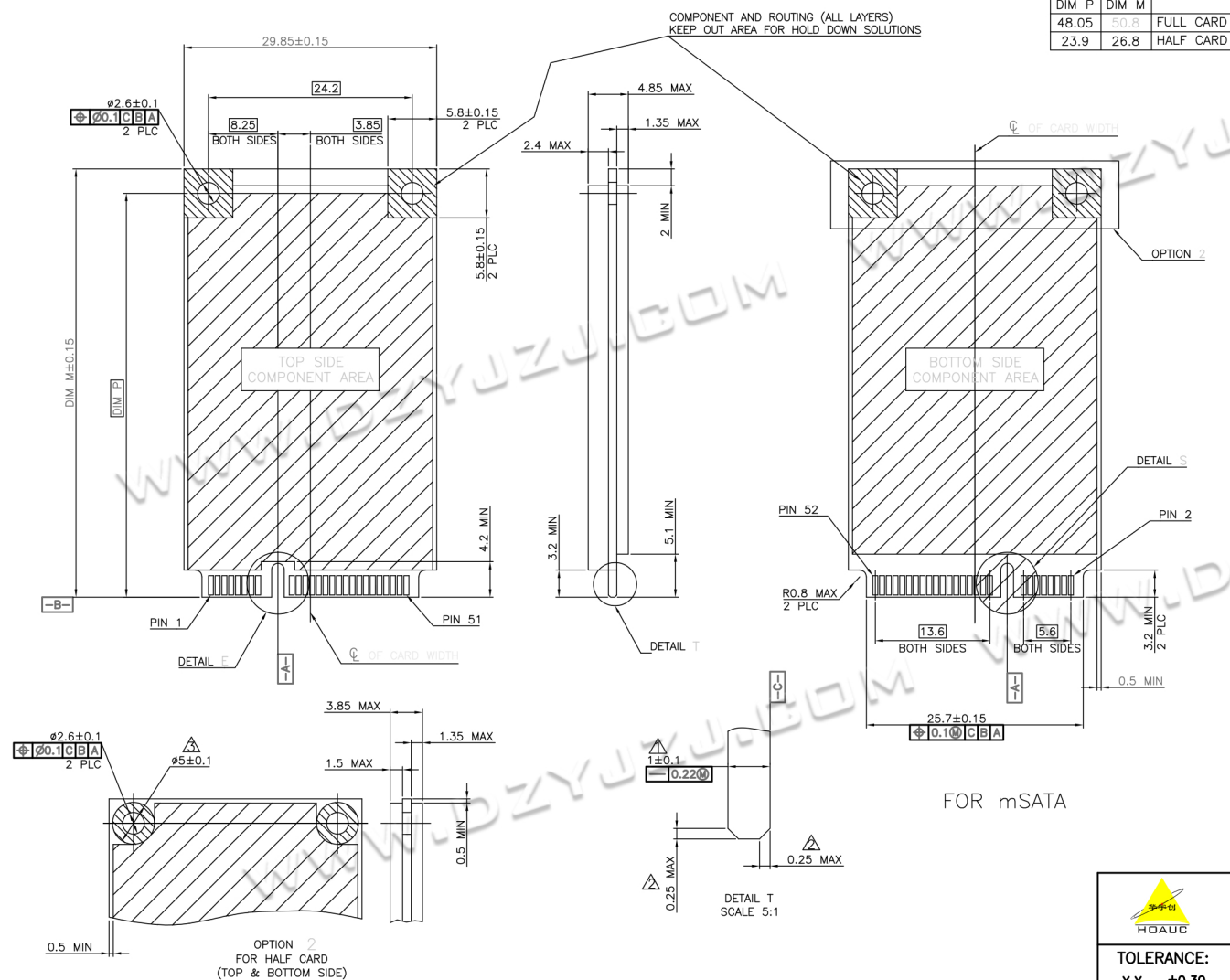
MOLD NO.

DRAW NO:

HYC-2411291042

SHEET NO.

1 OF 1



## NOTES:

- △ CARD THICKNESS APPLIES ACROSS TABS AND INCLUDES PLATING AND/OR METALLIZATION.
- △ EDGE BEVEL MUST BE PRESENT AND FREE OF CUTTING BURRS FROM PCB AND CONTACT MATERIALS.
- △ COMPONENT AND ROUTING (TOP/BOTTOM LAYER) KEEP OUT AREA FOR HOLD DOWN SOLUTIONS.

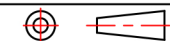


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## TOLERANCE:

X.X ±0.30  
X.XX ±0.25  
X.XXX ±0.15

X' ±2" X.X' ±0.5"



UNIT: mm [inch]

SCALE:1:1 SIZE: A4

## DRAWN BY :

陈一鸣

## CHECKED BY:

马跃

## APPROVED BY:

邱敏

## DATE :

2014-02-23

## DATE :

2014-02-23

## DATE :

2014-02-23

## PART NAME:

MINI PCI-E 9.9H

## PART NO.

HYC43-PCI52-990

## MOLD NO.

## DRAW NO:

HYC-2411291042

## SHEET NO.

1 OF 1